NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE3045G uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!

General Features

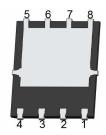
V_{DS} =30V,I_D =45A
 R_{DS(ON)}=6.9mΩ (typical) @ V_{GS}=10V

 $R_{DS(ON)}$ =11.6m Ω (typical) @ V_{GS} =4.5V

- High density cell design for ultra low Rdson
- Very low on-resistance R_{DS(on)}
- Good stability and uniformity with high E_{AS}
- 150 °C operating temperature
- Pb-free lead plating

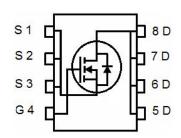
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE3045G	NCE3045G	DFN 5x6-8L	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	45	А
Drain Current-Continuous(T _C =100 ℃)	I _D (100°C)	31.8	А
Pulsed Drain Current ^(Note 1)	I _{DM}	180	А
Maximum Power Dissipation	P _D	50	W
Derating factor		0.4	W/°C
Single pulse avalanche energy (Note 5)	Eas	105	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}\!\mathbb{C}$

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{eJC}	2.5	°C/W



Electrical Characteristics (TC=25°Cunless otherwise noted)

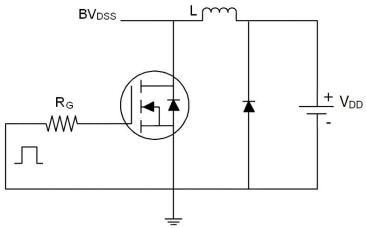
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			'			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.7	2.5	V
Drain-Source On-State Resistance	В	V _{GS} =10V, I _D =20A	-	6.9	8.5	m0
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A	-	11.6	16	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	20	-	-	S
Dynamic Characteristics (Note4)				•		
Input Capacitance	Clss	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	1220	-	PF
Output Capacitance	Coss		_	155	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UMHZ	-	145	-	PF
Switching Characteristics (Note 4)	,		•			
Turn-on Delay Time	t _{d(on)}		-	7	-	nS
Turn-on Rise Time	tr	V _{DD} =15V,I _D =20A	-	4	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =6 Ω	-	19	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg	V 45VI 00A	-	28	-	nC
Gate-Source Charge	Qgs	V _{DD} =15V,I _D =20A	-	4.0	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} -10V	-	6.0	-	nC
Drain-Source Diode Characteristics	·		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	0.85	1.2	V
Diode Forward Current (Note 2)	Is		-	-	45	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, I _F = 20A	-	-	27	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/μs ^(Note3)	-	-	20	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			y LS+LD)	

Notes:

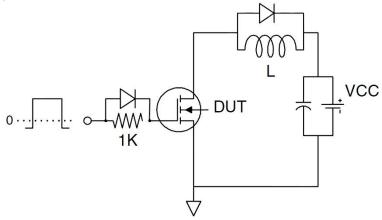
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=15V,V_G=10V,L=0.5mH,Rg=25 Ω

Test Circuit

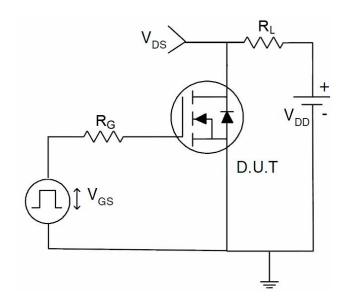
1) E_{AS} Test Circuits



2) Gate Charge Test Circuit

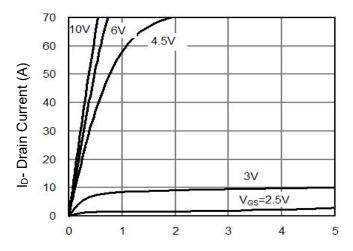


3) Switch Time Test Circuit



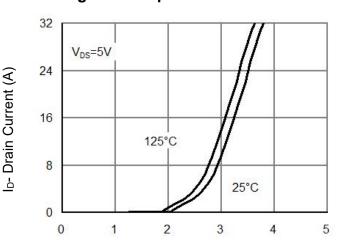


Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

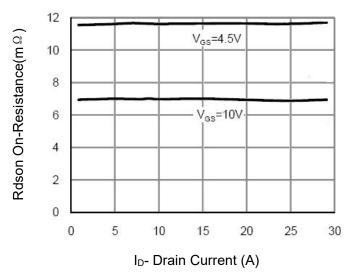


Figure 3 Rdson- Drain Current

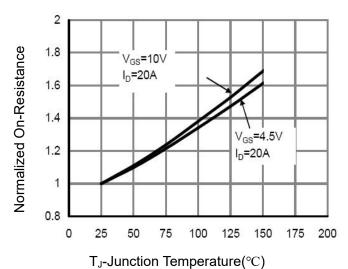


Figure 4 Rdson-JunctionTemperature

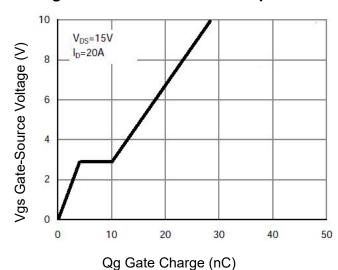
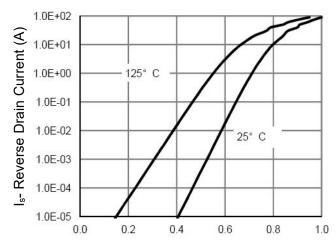


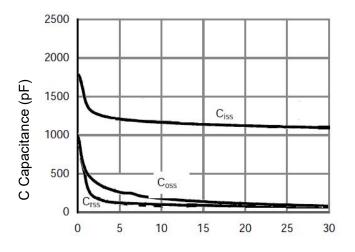
Figure 5 Gate Charge



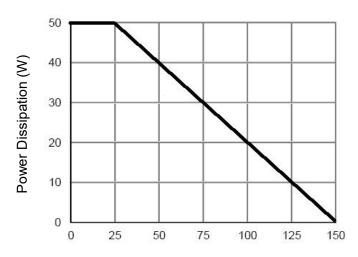
Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds



T_J-Junction Temperature(°C) **Figure 9 Power De-rating**

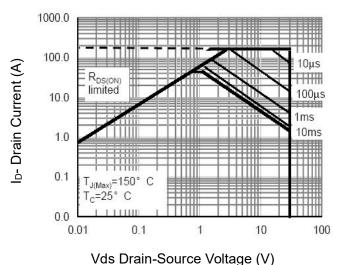
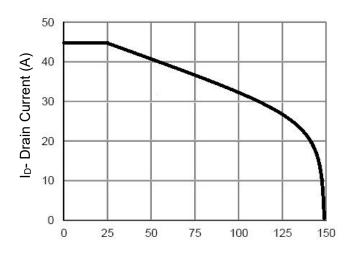


Figure 8 Safe Operation Area



 $T_{J}\text{-Junction Temperature}(^{\circ}\mathrm{C})$ Figure 10 ID Current- Junction Temperature

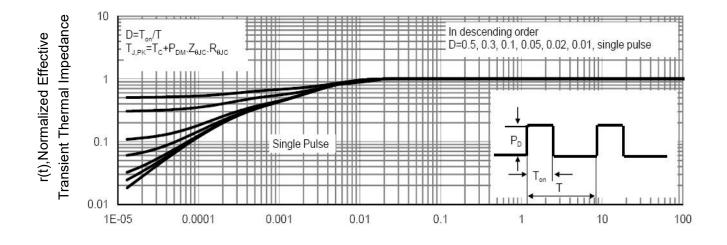
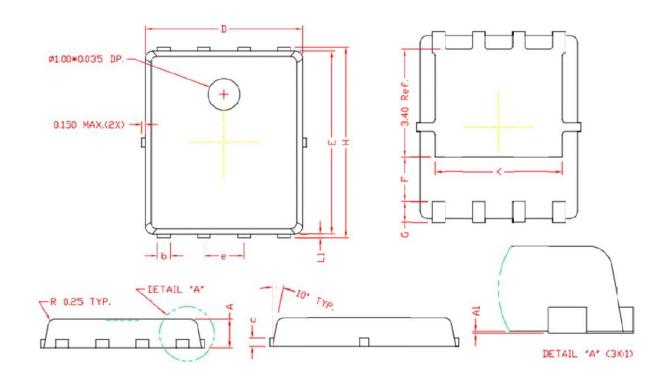


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)

DFN5X6-8L Package Information



COMMON DIMENSIONS

(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX		
A	0.80	0.90	1.00		
A1	0.00	0.03	0.05		
Ь	0.35	0.42	0.49		
С	0	254 REF	₹.		
D	4.90	5.00	5. 10		
F	1.40 REF.				
Е	5. 70	5.80	5. 90		
е	1	. 27 BSC			
Н	5. 95	6. 08	6. 20		
L1	0.10	0. 14	0. 18		
G	0.60 REF.				
K 4.00 REF.					

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